

EAD-M1

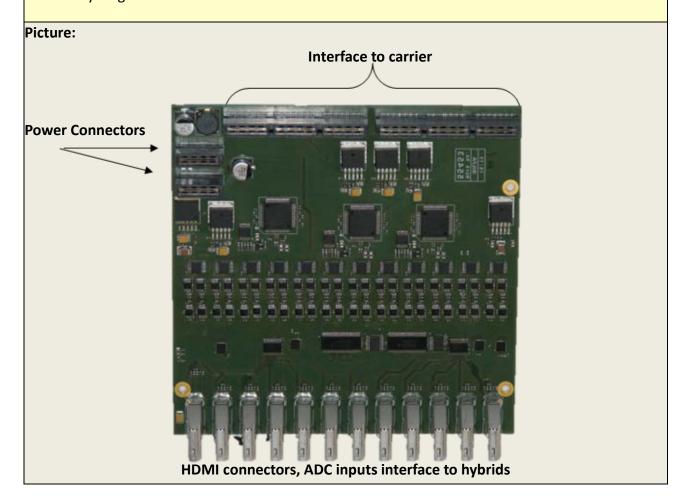
General Description:

EAD-M1 mezzanine board is designed to acquire data from a front-end electronics module according to the requirements. It was designed to be installed in EATCA-100 and EATCA-101 carrier board and interface front-end electronics using HDMI cable on the front panel. The selection of maximum ADC sampling rate can be done during an order.

The input stage used for each out of 24 analog channels. It consists of two amplifiers/buffers connected in series. They provide proper common mode voltage matching, amplification and also introduce preemphasis filtering if required. The behavior of input stage can be adjusted by external controls.

The board accommodates 3 ADC chips (ADS5282). Each chip is equipped with 8 analog inputs and serial interface for fast data readout. The maximum sampling frequency is 80 MHz. The functionality of the ADC can be controlled via serial interface connected to carrier board via QSE connector. This includes test modes, output data format and standard, gain etc. For the full list of functions please refer to vendor's datasheet. In addition each ADC has two input Signals: RST and PD, which are also connected to carrier board.

Each ADC is equipped with local VREF generation sub-circuits, which can be configured on an assembly stage with OR resistors.





Embedded Integrated Control Systems

Description				
Physical			Customized Board fit to connect on	
			ATCA Blade EATCA-100; EATCA-101	
Standards	SRS ATCA		Customized mezzanine card	
Combatibility	SRS		EATCA-101; EATCA-100	
Configuration				
Electrical properties	Power consumption		<25Watt	
Chipset	ADS 5282		Frequence: 65MHz, 12bits, Bandwith 550 MHz	
Connectivity				
Frontpanel	12 Interfaces	HDMI Standard		
	Debug Interface	Front panel channel,		3 booth FPGAs and MMC
		Connector type		Micro USB
		Data throughput		3 Mbps
Input	24 analog			53 differential pairs
	channels 2V pp			LVDS < 10 ¹⁴ bit ⁻¹
Power	Input	12V DC		
	Output	5V -5V 6V 6V	12 A 1 A 6 A 1 A	
Other features				
Environmental	Operating temperature			0-50°C
	Storage temperature			-40 – 90°C
	Relative humidity		5 - 90%, non-condensing	
	Dimensions			Width: 145,33 mm Depth: 146,41 mm
	Weight			0.4 kg

Datasheet - 14.08.2015, Rev. 1.2

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